

Appl. No. 10/823,098  
Amdt. dated 04/11/2008  
Reply to Office action of 03/20/2008

**Amendment of the Abstract**

Please replace the current abstract with the following new abstract:

By thermally contacting a coil (located within a micro-structure) with a heat diffuser, that is thermally connected to the substrate through a thermally conductive pedestal, efficient transfer of heat from the coil to the substrate is facilitated.